

D1FT4A

Schottky Barrier Diodes
40V, 3A

Feature

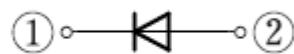
- Small SMD
- High Recovery Speed
- $T_j=175^\circ\text{C}$
- Ultra low I_R
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 1F
Package (JEDEC Code): DO-214AC



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : $T_I=25^\circ\text{C}$)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T_{STG}		-55 to 175	°C
Junction temperature	T_J		-55 to 175	°C
Repetitive peak reverse voltage	V_{RRM}		40	V
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, $T_I=127^\circ\text{C}$	3	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On alumina substrate, $T_a=25^\circ\text{C}$ *	2.2	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On glass-epoxy substrate, $T_a=25^\circ\text{C}$ *	1.6	A
Surge forward current	I_{FSM}	50Hz sine wave, Non-repetitive, 1cycle, Peak value, $T_j=25^\circ\text{C}$	90	A

* : See the original Specifications

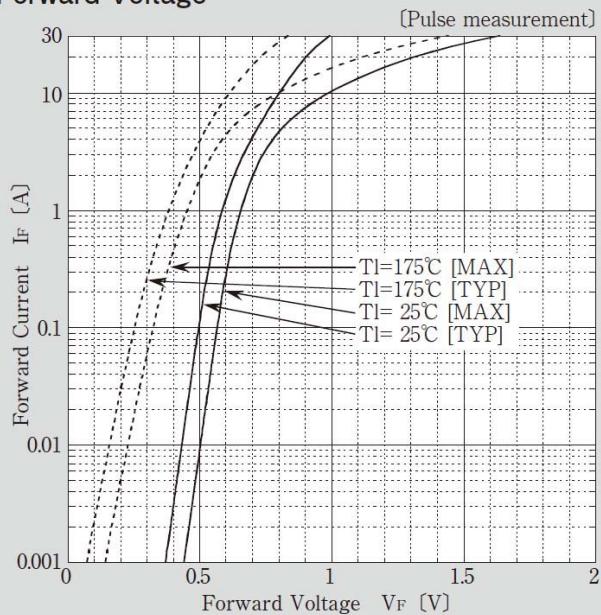
Electrical Characteristics (unless otherwise specified : T_l=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V _F	IF=3A, Pulse measurement			0.74	V
Forward voltage	V _F	IF=1A, Pulse measurement			0.66	V
Reverse current	I _R	VR=40V, Pulse measurement			0.008	mA
Total capacitance	C _t	f=1MHz, VR=10V		93		pF
Thermal resistance	R _{th(j-l)}	Junction to lead			23	°C/W
Thermal resistance	R _{th(j-a)}	Junction to ambient, On alumina substrate *			108	°C/W
Thermal resistance	R _{th(j-a)}	Junction to ambient, On glass-epoxy substrate *			157	°C/W

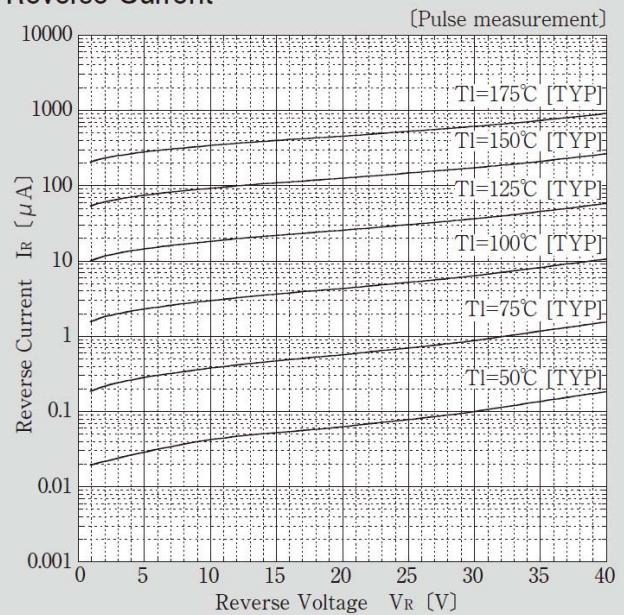
* : See the original Specifications

CHARACTERISTIC DIAGRAMS

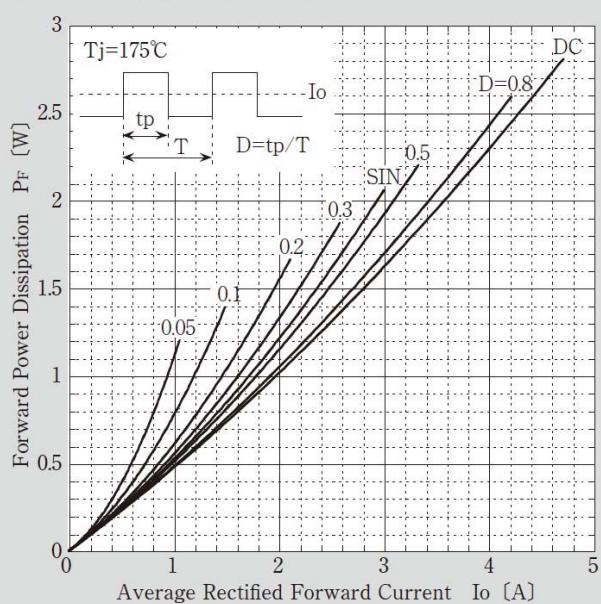
Forward Voltage



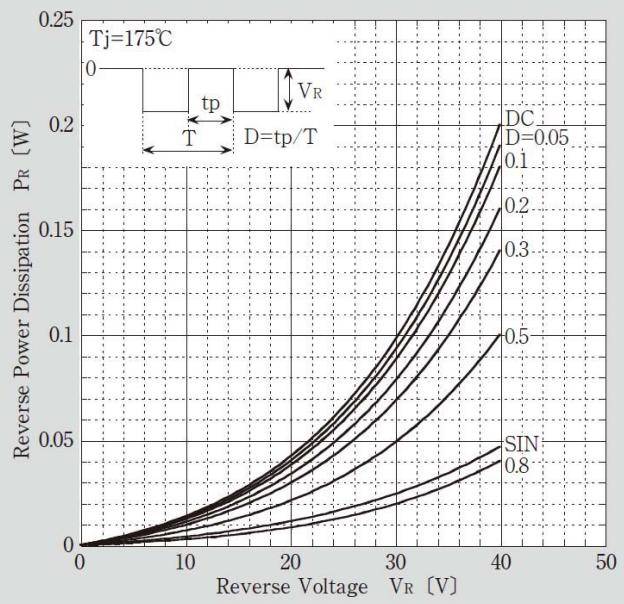
Reverse Current



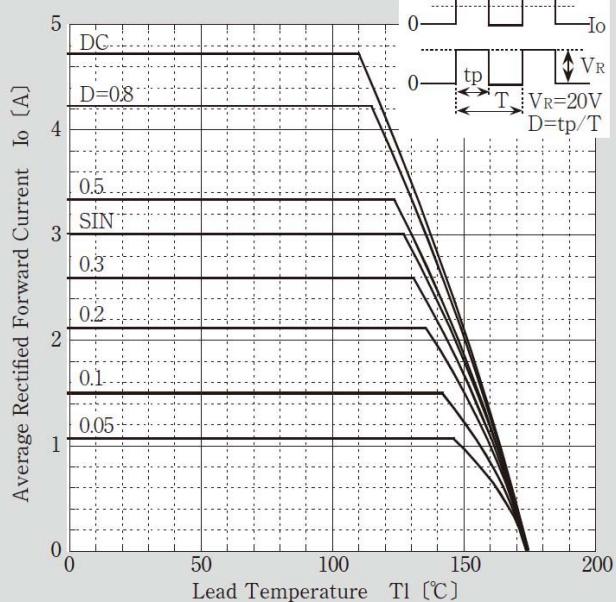
Forward Power Dissipation



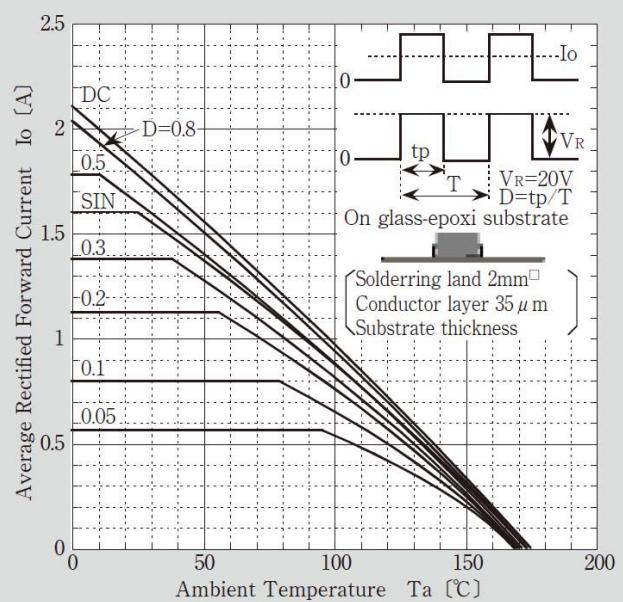
Reverse Power Dissipation



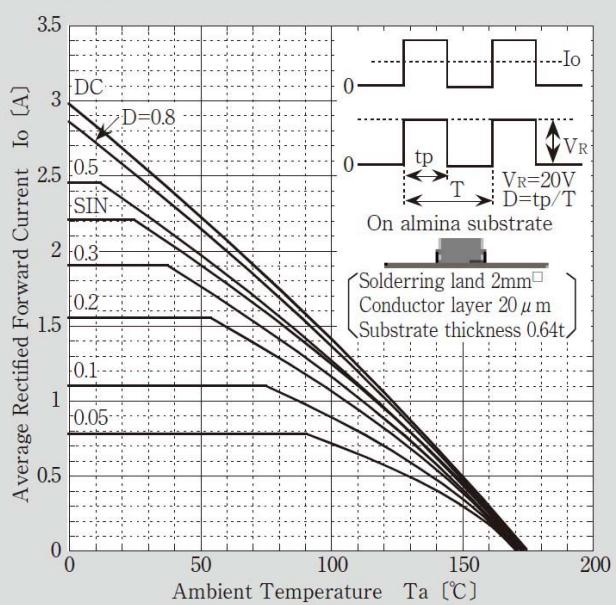
Derating Curve



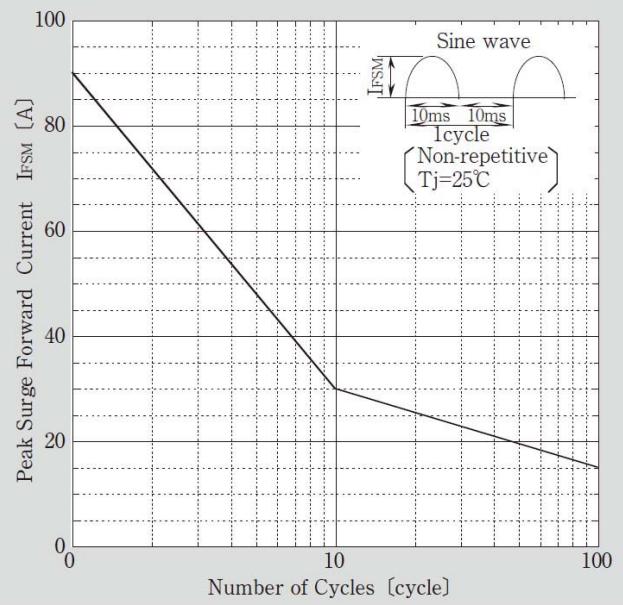
Derating Curve



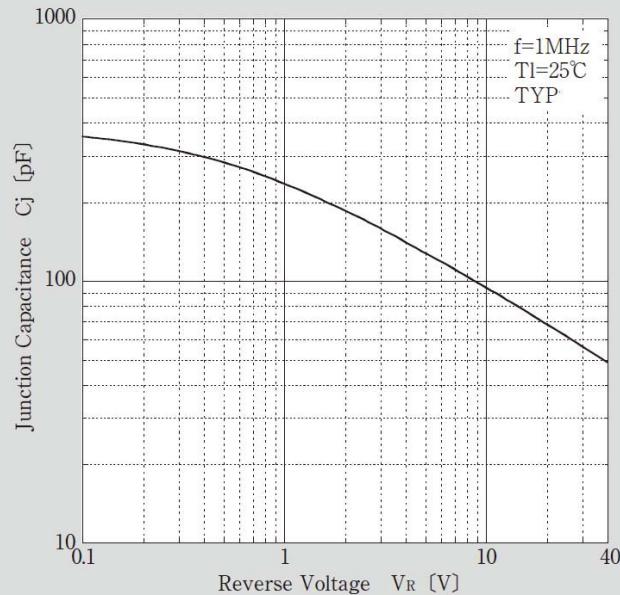
Derating Curve



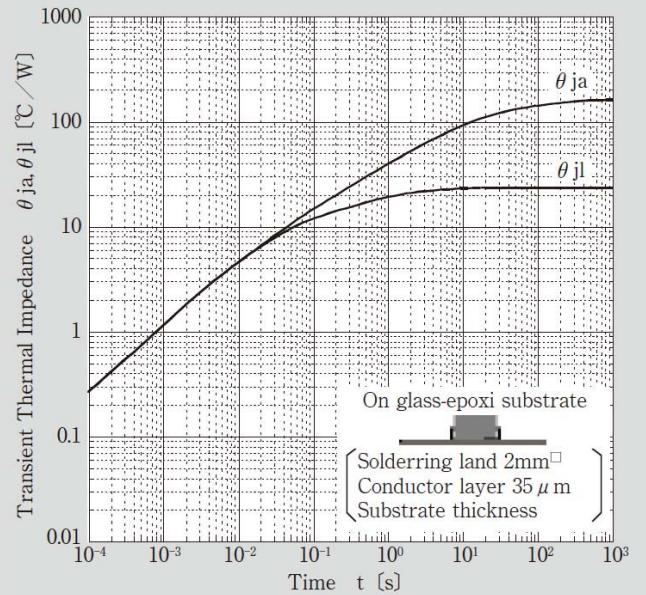
Peak Surge Forward Capability



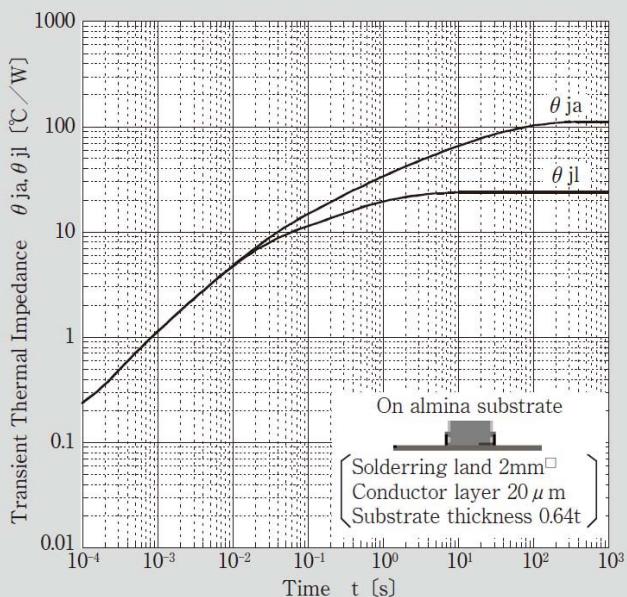
Junction Capacitance



Transient Thermal Impedance



Transient Thermal Impedance



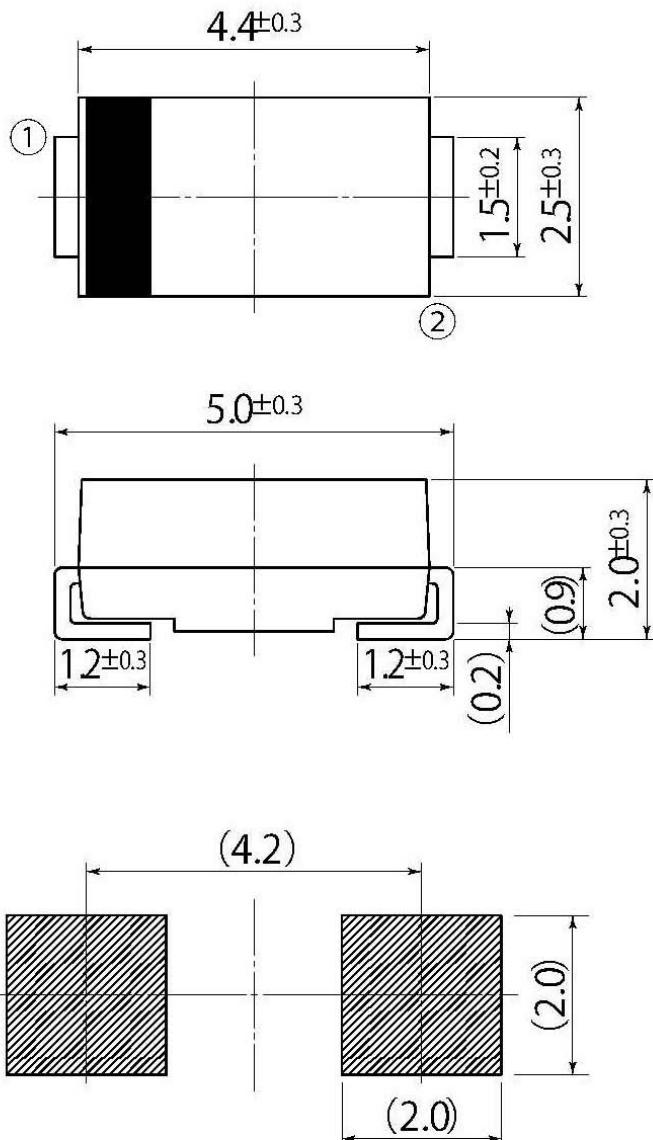
Outline Dimensions

unit:mm

scale: 10/1

B3

JEDEC Code	DO-214AC
JEITA Code	-
House Name	1F, CF



Referential Soldering Pad

- Optimize soldering pad to the board design and soldering condition.